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PATENT APPLICATION

THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re application of

Docket No: Q64434

Akihisa MURATA, et al.

Appln. No.: 09/853,787 ✓

Group Art Unit: 1771 ✓

Confirmation No.: 7102

Examiner: Daniel R. Zirker ✓

Filed: May 14, 2001 ✓

For: HEAT-PEELABLE PRESSURE-SENSITIVE ADHESIVE SHEET

AMENDMENT UNDER 37 C.F.R. § 1.111

Commissioner for Patents
Washington, D.C. 20231

Sir:

In response to the outstanding Office Action dated August 1, 2002, review and reconsideration on the merits are respectfully requested in view of the following remarks and amendments.

IN THE CLAIMS:

Please cancel claim 1 without prejudice or disclaimer.

Claims 2, 3 and 4 have been amended.

AI 2. (Amended) The heat-peelable pressure-sensitive adhesive sheet as claimed in claim 3, wherein the heat-expandable pressure-sensitive adhesive layer before heating has a center line average surface roughness of 2 μm or less.

3. (Amended) A heat-peelable pressure-sensitive adhesive sheet comprising a substrate and formed on at least one side thereof a heat-expandable pressure-sensitive adhesive layer containing heat-expandable microspheres, wherein the heat-expandable pressure-sensitive